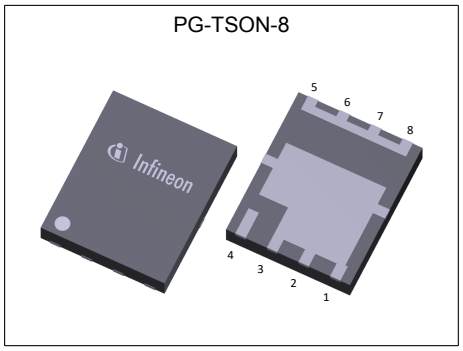
MOSFET

OptiMOS™ 5 Power-Transistor, 60 V



Features

- N-channel, logic level
- Very low on-resistance $R_{DS(on)}$
- Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21

Product validation

Fully qualified according to JEDEC for Industrial Applications

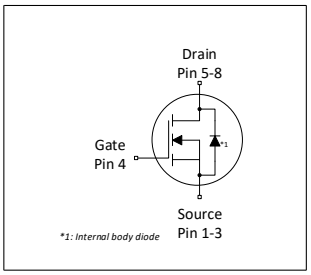


Table 1 Key Performance Parameters

Parameter	Value	Unit
V_{DS}	60	V
$R_{DS(on),max}$	0.86	mΩ
I_D	447	A
Q_{oss}	133	nC
Q_G	76	nC

Type / Ordering Code	Package	Marking	Related Links
IQDH88N06LM5	PG-TSON-8	H8806L5	-

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1 Maximum ratings

at T_A=25 °C, unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Continuous drain current[1]	I_D	- - - -	- - - -	447 316 263 42	A	V_{GS}=10 V, T_C=25 °C V_{GS}=10 V, T_C=100 °C V_{GS}=4.5 V, T_C=100 °C V_{GS}=10 V,T_A=25 °C,R_{thJA}=50 °C/W[2]
Pulsed drain current[3]	$I_{D,pulse}$	-	-	1788	A	T_C=25 °C
Avalanche energy, single pulse[4]	E_{AS}	-	-	1115	mJ	I_D=50 A, R_{GS}=25 Ω
Gate source voltage	V_{GS}	-20	-	20	V	-
Power dissipation	P_{tot}	- -	- -	333 3.0	W	T_C=25 °C T_A=25 °C, R_{thJA}=50 °C/W[2]
Operating and storage temperature	T_j, T_{stg}	-55	-	175	°C	-

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Thermal resistance, junction - case	R_{thJC}	-	-	0.45	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area[2]	R_{thJA}	-	-	50	°C/W	-

[1] Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.
[2] Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for source connection. PCB is vertical in still air.
[3] See Diagram 3 for more detailed information
[4] See Diagram 13 for more detailed information

3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Drain-source breakdown voltage	$V_{(BR)DSS}$	60	-	-	V	V_{GS}=0 V, I_D=1 mA
Gate threshold voltage	$V_{GS(th)}$	1.1	1.7	2.3	V	V_{DS}=V_{GS}, I_D=163 µA
Zero gate voltage drain current	I_{DSS}	- -	0.1 10	1 100	µA	V_{DS}=60 V, V_{GS}=0 V, T_j=25 °C V_{DS}=60 V, V_{GS}=0 V, T_j=125 °C
Gate-source leakage current	I_{GSS}	-	10	100	nA	V_{GS}=20 V, V_{DS}=0 V
Drain-source on-state resistance	$R_{DS(on)}$	- -	0.7 1.0	0.86 1.24	mΩ	V_{GS}=10 V, I_D=50 A V_{GS}=4.5 V, I_D=50 A
Gate resistance	R_G	-	0.55	-	Ω	-
Transconductance	g_{fs}	115	230	-	S	|V_{DS}|≥2|I_D|$R_{DS(on)max}$, I_D=50 A

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Input capacitance[1)]	C_{iss}	-	11000	14000	pF	V_{GS}=0 V, V_{DS}=30 V, f=1 MHz
Output capacitance[1)]	C_{oss}	-	2000	2600	pF	V_{GS}=0 V, V_{DS}=30 V, f=1 MHz
Reverse transfer capacitance[1)]	C_{rss}	-	95	170	pF	V_{GS}=0 V, V_{DS}=30 V, f=1 MHz
Turn-on delay time	$t_{d(on)}$	-	14	-	ns	V_{DD}=30 V, V_{GS}=10 V, I_D=50 A, $R_{G,ext}$=1.6 Ω
Rise time	t_r	-	8	-	ns	V_{DD}=30 V, V_{GS}=10 V, I_D=50 A, $R_{G,ext}$=1.6 Ω
Turn-off delay time	$t_{d(off)}$	-	53	-	ns	V_{DD}=30 V, V_{GS}=10 V, I_D=50 A, $R_{G,ext}$=1.6 Ω
Fall time	t_f	-	16	-	ns	V_{DD}=30 V, V_{GS}=10 V, I_D=50 A, $R_{G,ext}$=1.6 Ω

Table 6 Gate charge characteristics[2)]

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Gate to source charge	Q_{gs}	-	27	-	nC	V_{DD}=30 V, I_D=50 A, V_{GS}=0 to 4.5 V
Gate charge at threshold	$Q_{g(th)}$	-	18	-	nC	V_{DD}=30 V, I_D=50 A, V_{GS}=0 to 4.5 V
Gate to drain charge[1)]	Q_{gd}	-	22	33	nC	V_{DD}=30 V, I_D=50 A, V_{GS}=0 to 4.5 V
Switching charge	Q_{sw}	-	31	-	nC	V_{DD}=30 V, I_D=50 A, V_{GS}=0 to 4.5 V
Gate charge total[1)]	Q_g	-	76	95	nC	V_{DD}=30 V, I_D=50 A, V_{GS}=0 to 4.5 V
Gate plateau voltage	$V_{plateau}$	-	2.5	-	V	V_{DD}=30 V, I_D=50 A, V_{GS}=0 to 4.5 V
Gate charge total[1)]	Q_g	-	152	202	nC	V_{DD}=30 V, I_D=50 A, V_{GS}=0 to 10 V
Gate charge total, sync. FET	$Q_{g(sync)}$	-	62	-	nC	V_{DS}=0.1 V, V_{GS}=0 to 4.5 V
Output charge[1)]	Q_{oss}	-	133	177	nC	V_{DS}=30 V, V_{GS}=0 V

[1)] Defined by design. Not subject to production test.
[2)] See ″Gate charge waveforms″ for parameter definition

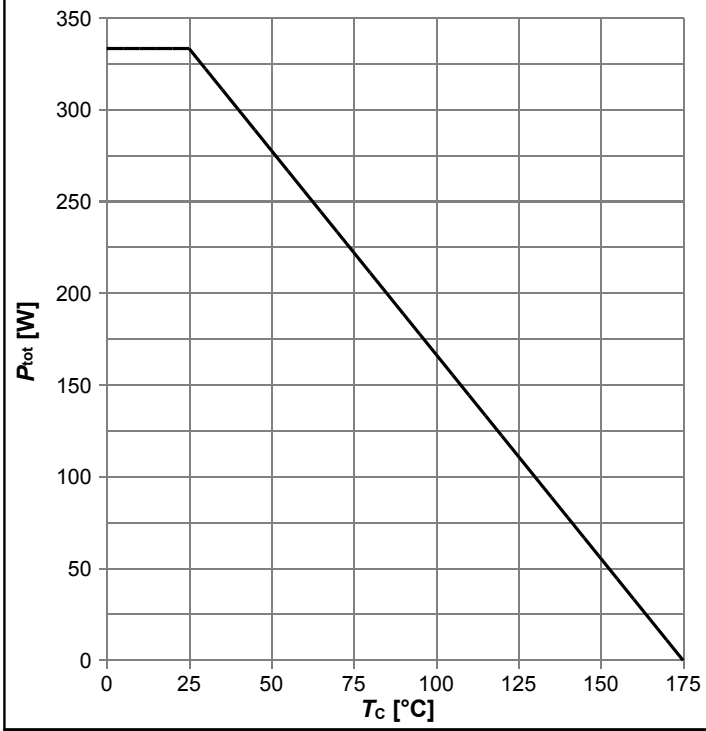
Table 7 Reverse diode

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Diode continuous forward current	I_S	-	-	271	A	T_C=25 °C
Diode pulse current	$I_{S,pulse}$	-	-	1788	A	T_C=25 °C
Diode forward voltage	V_{SD}	-	0.77	1.0	V	V_{GS}=0 V, I_F=50 A, T_j=25 °C
Reverse recovery time[1)]	t_{rr}	-	44	88	ns	V_R=30 V, I_F=25 A, di_F/dt=100 A/µs
Reverse recovery charge[1)]	Q_{rr}	-	49	98	nC	V_R=30 V, I_F=25 A, di_F/dt=100 A/µs
Reverse recovery time[1)]	t_{rr}	-	27	54	ns	V_R=30 V, I_F=50 A, di_F/dt=1000 A/µs
Reverse recovery charge[1)]	Q_{rr}	-	256	512	nC	V_R=30 V, I_F=50 A, di_F/dt=1000 A/µs

[1)] Defined by design. Not subject to production test.

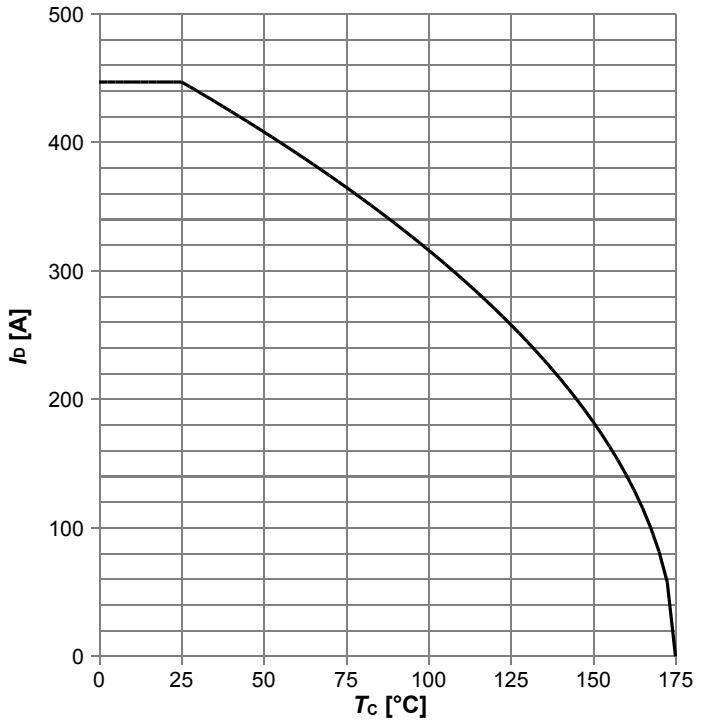
4 Electrical characteristics diagrams

Diagram 1: Power dissipation



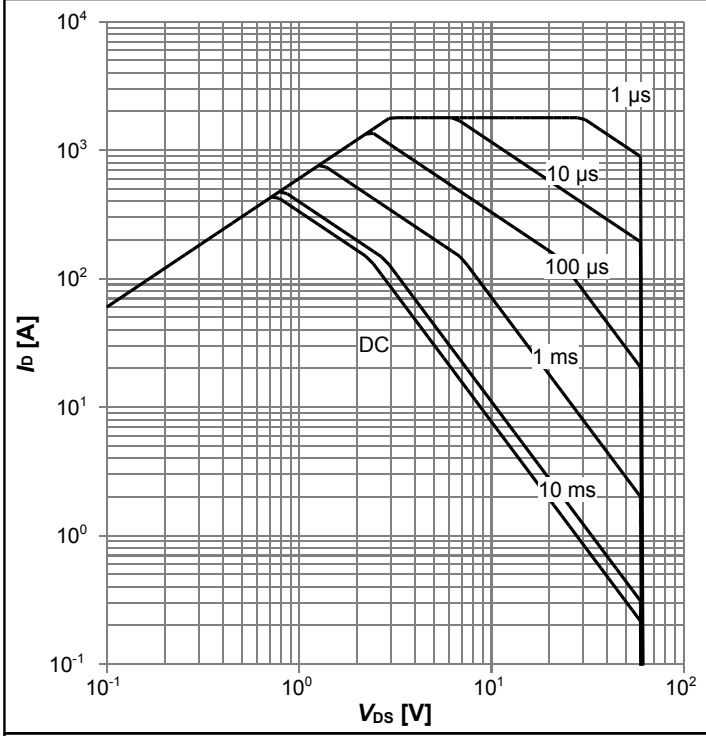
$P_{tot}=f(T_C)$

Diagram 2: Drain current



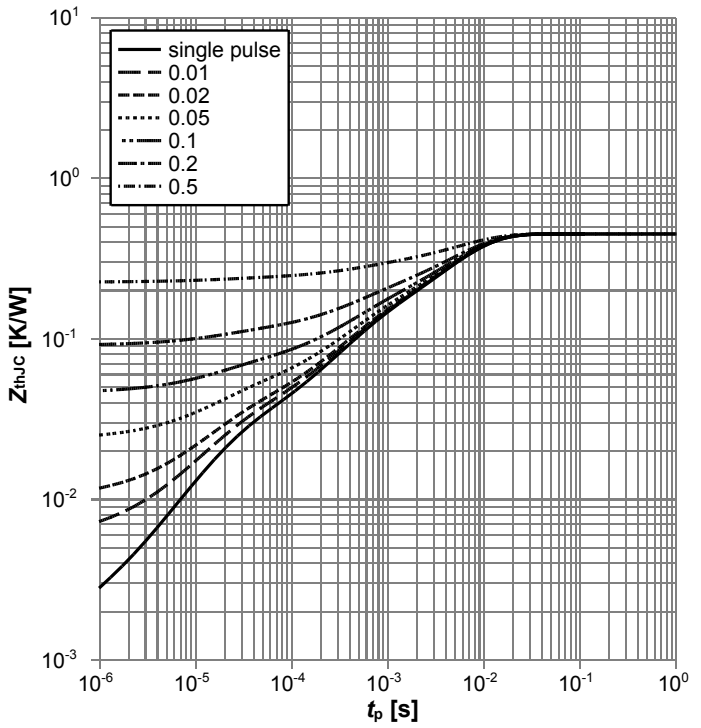
$I_D=f(T_C)$; $V_{GS}\geq 10$ V

Diagram 3: Safe operating area



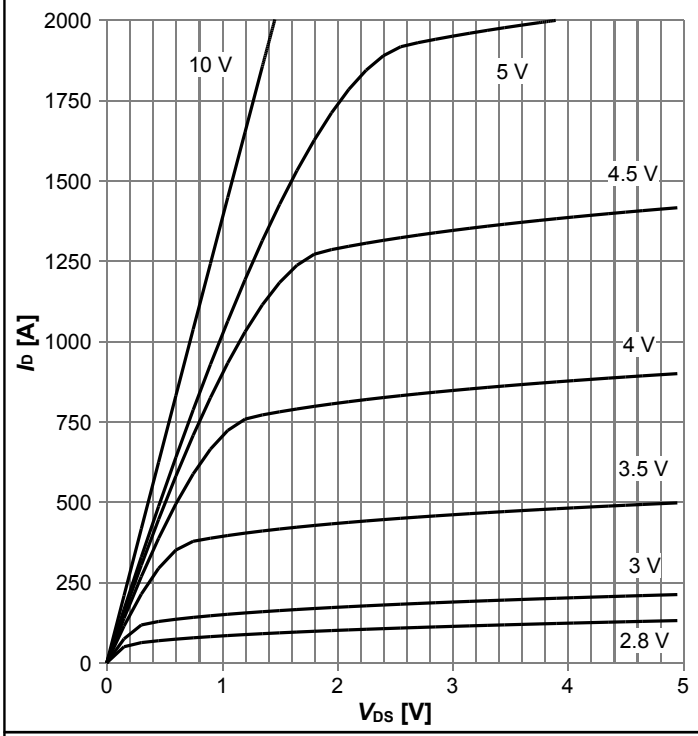
$I_D=f(V_{DS})$; T_C=25 °C; D=0; parameter: t_p

Diagram 4: Max. transient thermal impedance



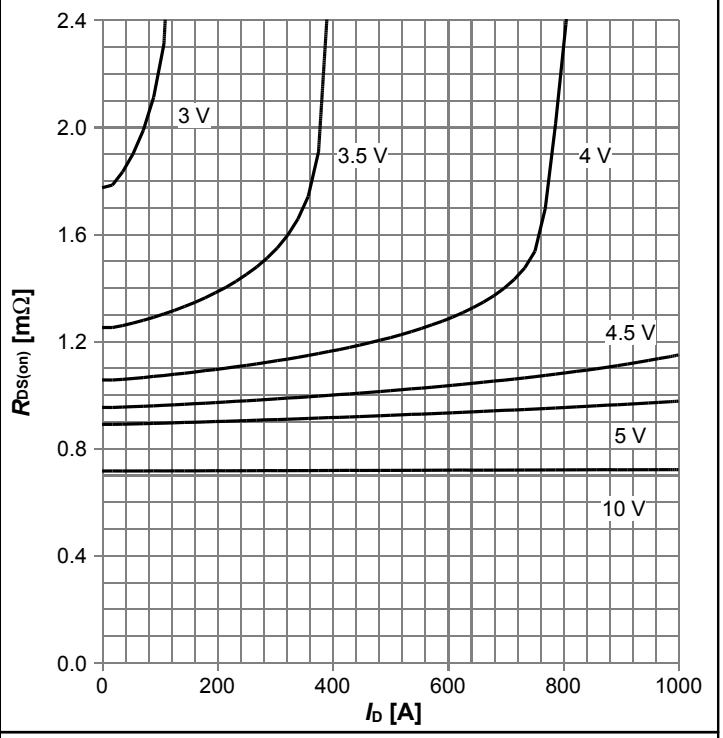
$Z_{thJC}=f(t_p)$; parameter: $D=t_p/T$

Diagram 5: Typ. output characteristics



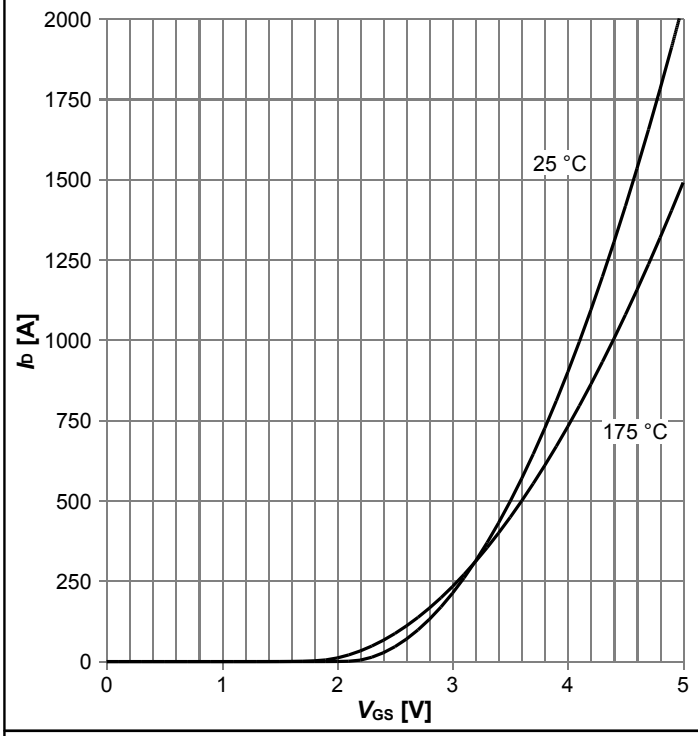
I_D=f(V_{DS}), T_j=25 °C; parameter: V_{GS}

Diagram 6: Typ. drain-source on resistance



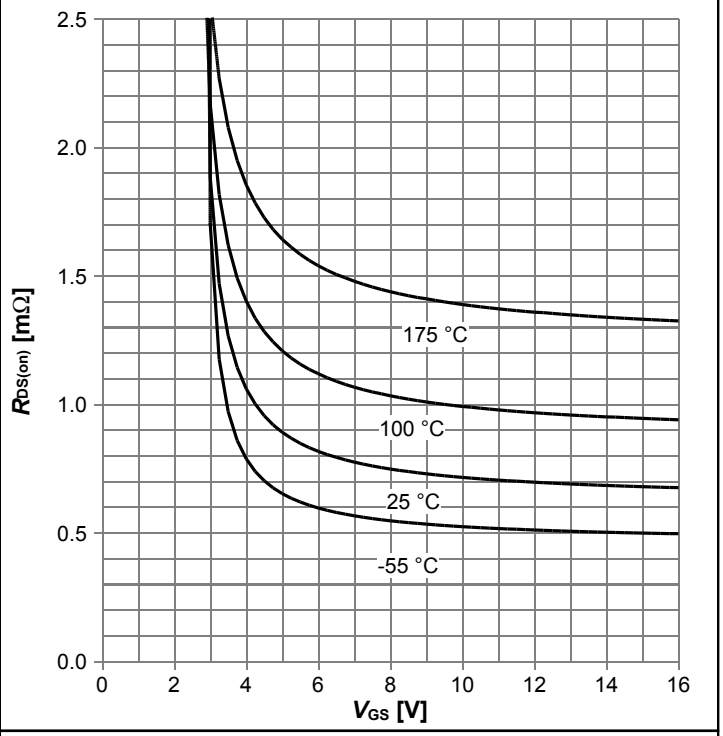
$R_{DS(on)}$=f(I_D), T_j=25 °C; parameter: V_{GS}

Diagram 7: Typ. transfer characteristics



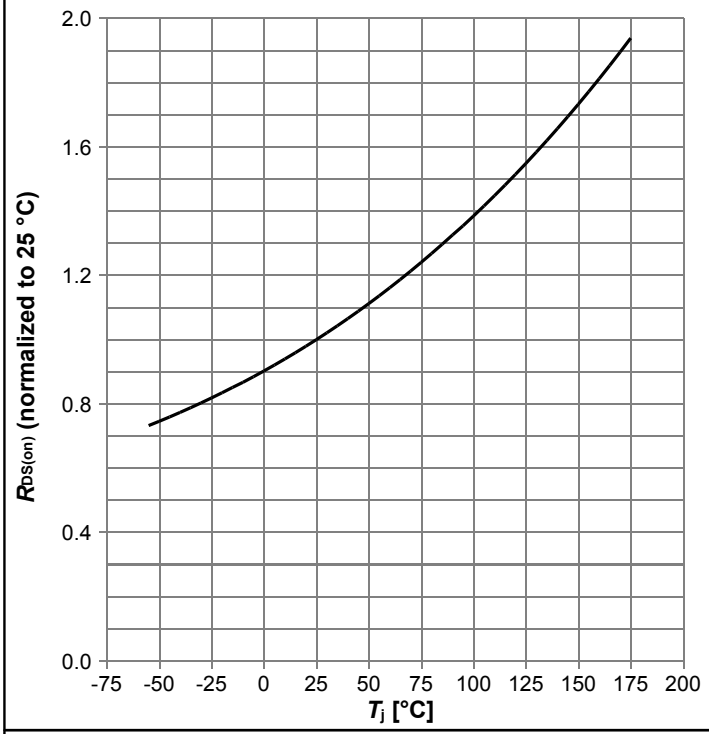
I_D=f(V_{GS}), |V_{DS}|>2|I_D|$R_{DS(on)max}$; parameter: T_j

Diagram 8: Typ. drain-source on resistance



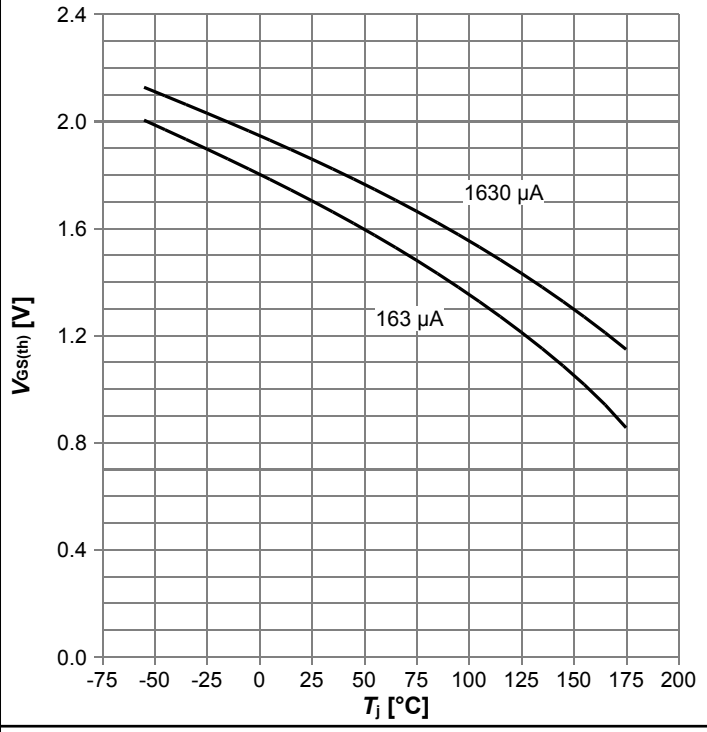
$R_{DS(on)}$=f(V_{GS}), I_D=50 A; parameter: T_j

Diagram 9: Normalized drain-source on resistance



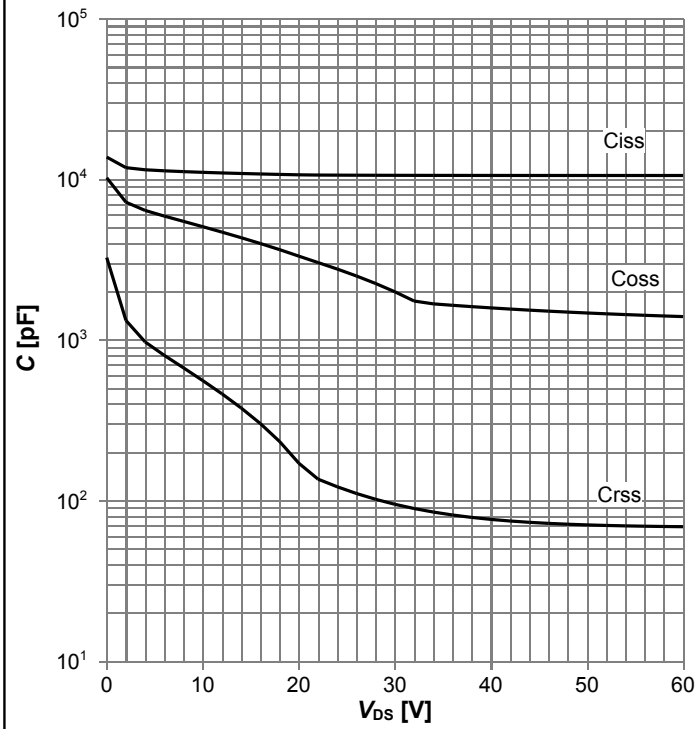
$R_{DS(on)}$=f(T_j), I_D=50 A, V_{GS}=10 V

Diagram 10: Typ. gate threshold voltage



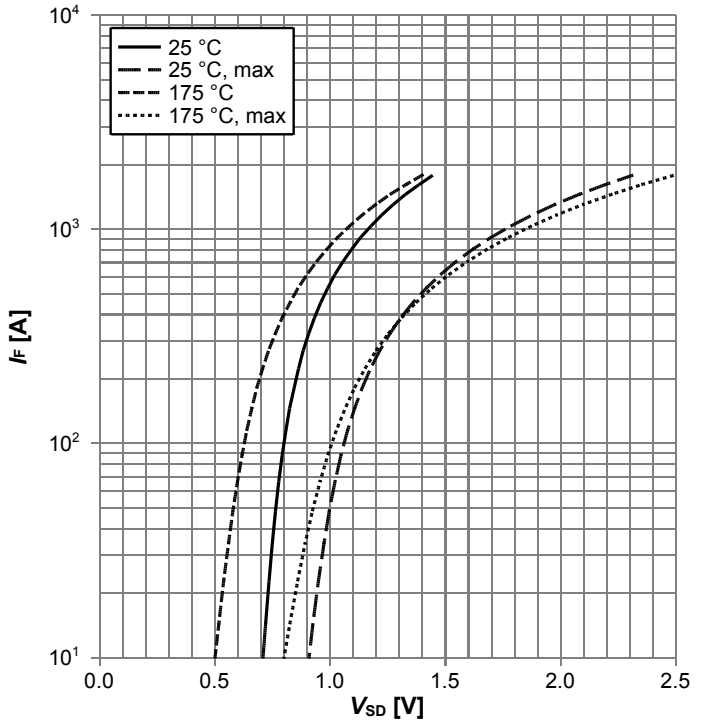
$V_{GS(th}$=f(T_j), V_{GS}=V_{DS}; parameter: I_D

Diagram 11: Typ. capacitances



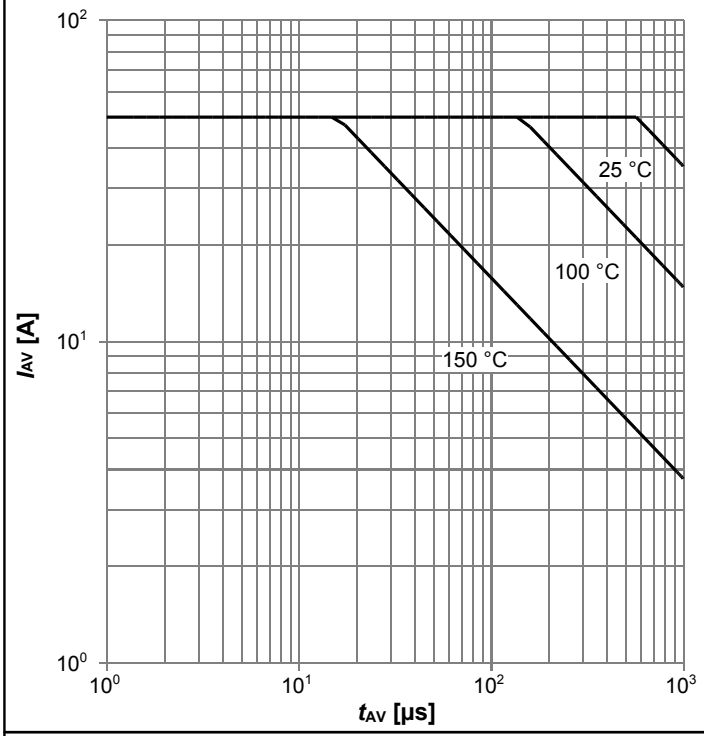
C=f(V_{DS}); V_{GS}=0 V; f=1 MHz

Diagram 12: Forward characteristics of reverse diode



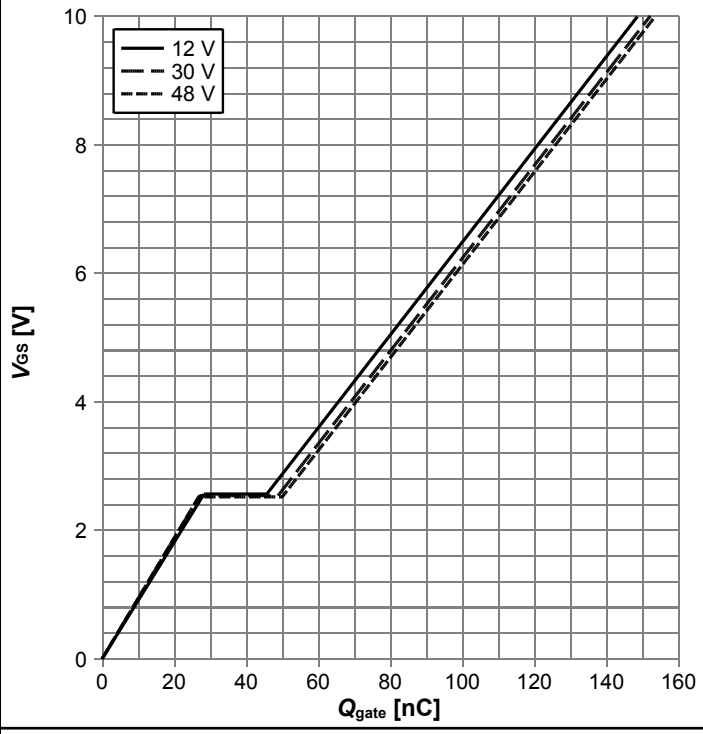
I_F=f(V_{SD}); parameter: T_j

Diagram 13: Avalanche characteristics



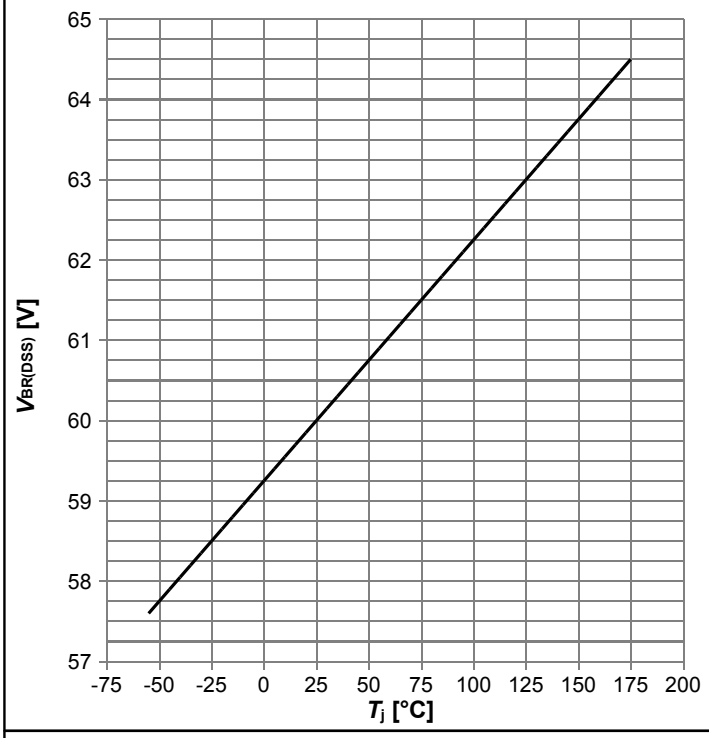
I_{AS}=f(t_{AV}); R_{GS}=25 Ω; parameter: $T_{j,start}$

Diagram 14: Typ. gate charge



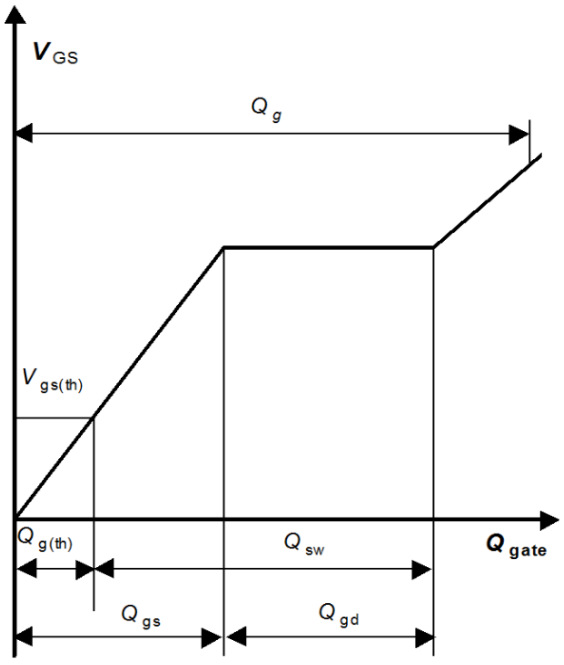
V_{GS}=f(Q_{gate}), I_D=50 A pulsed, T_j=25 °C; parameter: V_{DD}

Diagram 15: Min. drain-source breakdown voltage

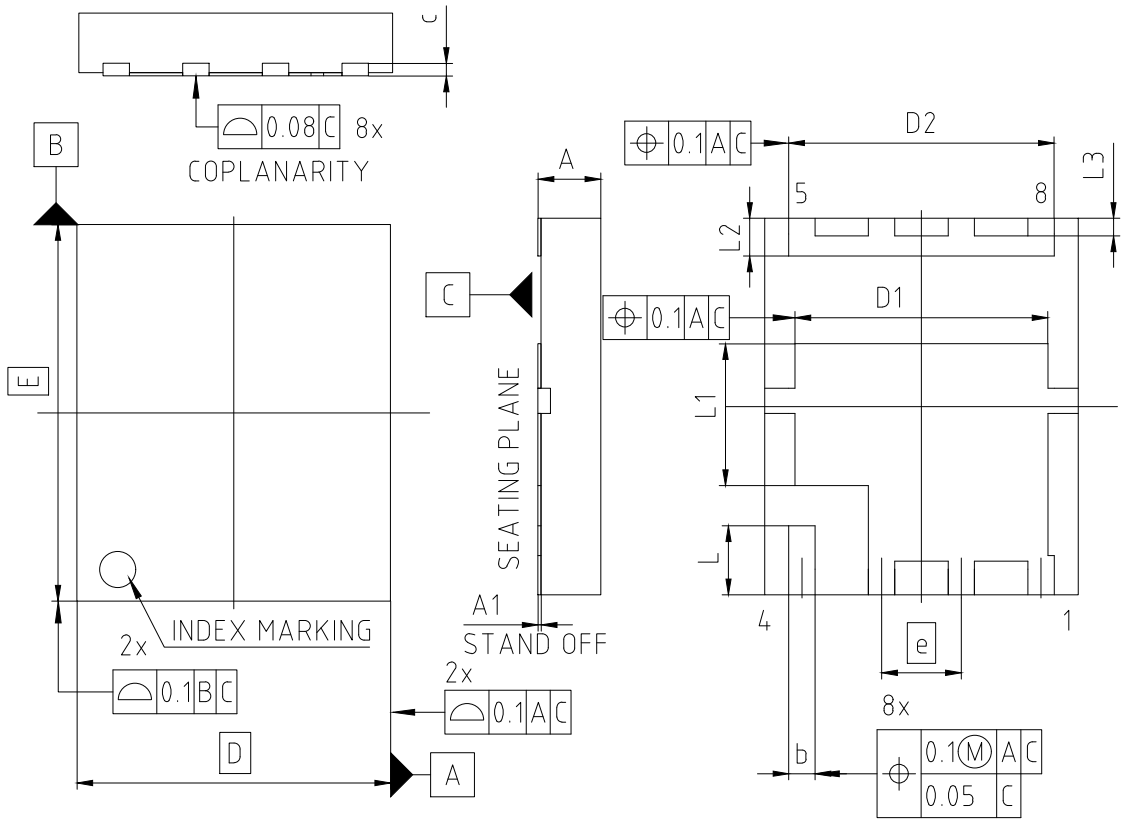


$V_{BR(DSS)}$=f(T_j); I_D=1 mA

Diagram Gate charge waveforms



5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-TSON-8-U04	
DIMENSIONS	**MILLIMETERS**	
	MIN.	MAX.
A	---	1.10
A1	---	0.05
b	0.37	0.47
c	**0.20**	
D	**5.00**	
D1	3.93	4.13
D2	4.13	4.33
E	**6.00**	
e	**1.27**	
L	1.00	1.20
L1	2.16	2.36
L2	0.50	0.70
L3	0.18	0.38
N	**8**	

NOTE:
DIMENSIONS DO NOT INCLUDE MOLD FLASH,
PROTRUSION OR GATE BURRS

Figure 1 Outline PG-TSON-8, dimensions in mm

Revision History

IQDH88N06LM5

Revision: 2023-08-16, Rev. 2.0

Previous Revision		
Revision	Date	Subjects (major changes since last revision)
2.0	2023-08-16	Release of final version

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